

80V N-Channel Power MOSFET

Description

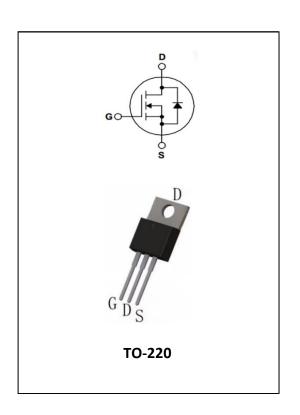
The P75NF75 uses advanced trench technology to Provide excellent $R_{DS(ON)}$, low gate charge. It can be used in a wide variety of applications.

KEY CHARACTERISTICS

- (1) $V_{DS} = 80V, I_D = 80A$ $R_{DS(ON)} < 12m\Omega @ V_{GS} = 10V$
- 2 Special process technology for high ESD capability
- (3) High density cell design for lower Rdson
- (4) Fully characterized avalanche voltage and current
- Good stability and uniformity with high EAS
- 6 Excellent package for good heat dissipation

Application

- 1 Power switching application
- 2 Hard switched and High frequency circuits
- (3) Uninterruptible power supply



Package Marking And Ordering Information:

Ordering Codes	Package	Product Code	Packing
P75NF75	TO-220	P75NF75	Tube

Absolute Maximum Ratings (TA=25°C unless otherwise noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V _{DS}	80	V
Gate-Source Voltage	V _{GS}	±20	V
Drain Current-Continuous	I _D	80	Α
Drain Current-Pulsed (Note 1)	I _{DM}	280	Α
Maximum Power Dissipation(Tc=25 °C)	P _D	147	W
Single pulse avalanche energy(Note 2)	Eas	330	mJ
Operating Junction and Storage Temperature Range	T _J ,T _{STG}	-55 To 175	$^{\circ}$ C

Thermal Characteristic

Thermal Resistance, Junction-to-Case	R _{θJC}	1.02	°C/W
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	62.5	°C/W





Electrical Characteristics (TA=25 ℃ unless otherwise noted)

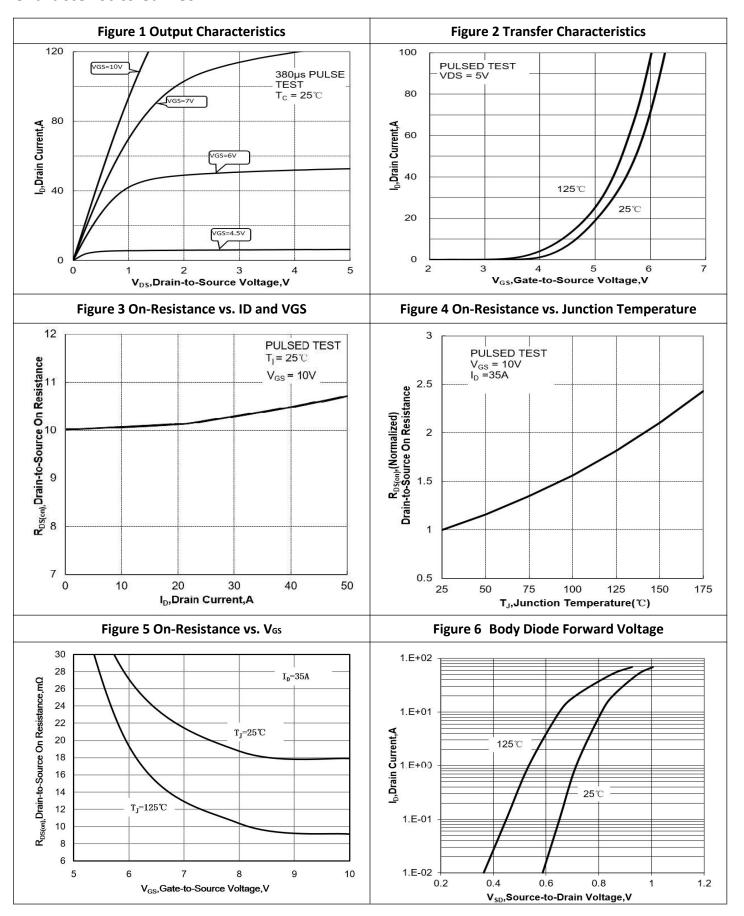
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Off Characteristics				•	•	
Drain-Source Breakdown Voltage	BV _{DSS}	V _{GS} =0V I _D =250μA	80	-	-	V
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V,V _{GS} =0V	-	-	1	μΑ
Gate-Body Leakage Current	I _{GSS}	V_{GS} =±20V, V_{DS} =0V	-	-	±100	nA
On Characteristics			•			
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250μA	2	3	4	V
Drain-Source On-State Resistance(Note 3)	R _{DS(ON)}	V _{GS} =10V, I _D =35A	-	10	12	mΩ
Forward Transconductance	g FS	V _{DS} =20V,I _D =35A	-	90	-	S
Dynamic Characteristics			•			
Input Capacitance	C _{lss}	V_{DS} =25V, V_{GS} =0V,	-	3950	-	pF
Output Capacitance	Coss		-	280	-	pF
Reverse Transfer Capacitance	C _{rss}	<i>f</i> =1.0MHz	-	210	-	pF
Switching Characteristics (Note 4)			·			
Turn-on Delay Time	t _{d(on)}		-	130	-	nS
Turn-on Rise Time	tr	V _{DD} =40V, I _D =35A,	-	200	-	nS
Turn-Off Delay Time	t _{d(off)}		-	350	-	nS
Turn-Off Fall Time	t _f	V_{GS} =10V, R_{GEN} =3 Ω		245	-	nS
Total Gate Charge	Qg		-	85	-	nC
Gate-Source Charge	Q _{gs}	$V_{DS}=64V$, $I_{D}=35A$	-	24	-	nC
Gate-Drain Charge	Q _{gd}	V_{GS} =10 V	-	28	-	nC
Drain-Source Diode Characteristics			1	•	•	
Diode Forward Voltage	V _{SD}	V _{GS} =0V,I _S =1A	-	-	1.2	V

Notes:

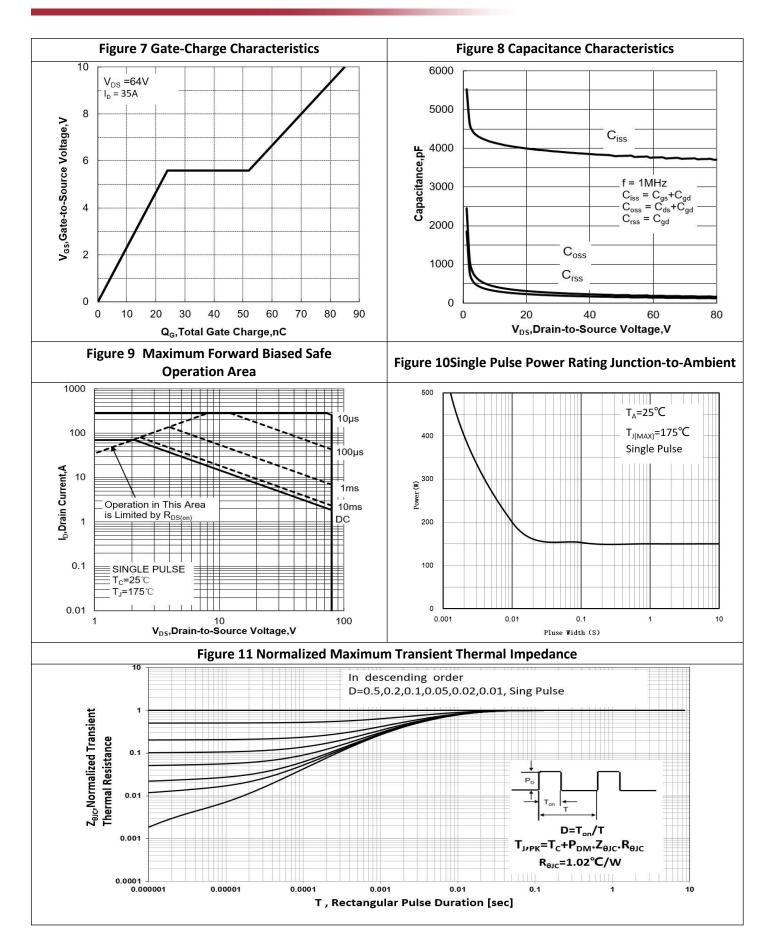
- 1. Repetitive Rating: Pulse width limited by maximum junction temperature.
- 2. EAS condition :T j=25 $^{\circ}$ C,L=0.5mH,VDD=50V,VG=10V, Rg=25 Ω .
- 3. Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%.
- 4. Guaranteed by design, not subject to production.



Characteristics Curves

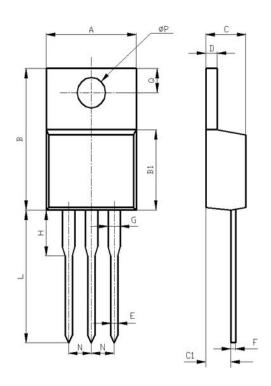








Package Description:



Items	Values(mm)		
	MIN	MAX	
Α	9.60	10.6	
В	15.0	16.0	
B1	8.90	9.50	
С	4.30	4.80	
C1	2.30	3.10	
D	1.20	1.40	
E	0.70	0.90	
F	0.30	0.60	
G	1.17	1.37	
Н	2.70	3.80	
L	12.6	14.8	
N	2.34	2.74	
Q	2.40	3.00	
фр	3.50	3.90	

TO-220 package



NOTE:

- 1. Exceeding the maximum ratings of the device in performance may cause damage to the device, even the permanent failure, which may affect the dependability of the machine. Please do not exceed the absolute maximum ratings of the device when circuit designing.
- 2. When installing the heat sink, please pay attention to the torsional moment and the smoothness of the heat sink.
- 3. MOSFETs is the device which is sensitive to the static electricity, it is necessary to protect the device from being damaged by the static electricity when using it.
- 4. Shenzhen Minos reserves the right to make changes in this specification sheet and is subject to change without prior notice.

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